



Receipt

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Hiroaki INOUE et al. :
Serial No. 09/880,005 : Attn: Application Branch
Filed June 14, 2001 : Attorney Docket No. 2001_0756A
ELECTROLESS PLATING LIQUID AND
SEMICONDUCTOR DEVICE : Confirmation No. 4689

REQUEST FOR CORRECTED FILING RECEIPT

Assistant Commissioner for Patents,
Washington, DC 20231

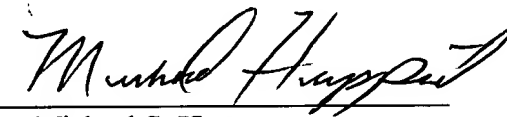
Sir:

A corrected filing receipt is requested in the above-referenced case. A copy of the original filing receipt is enclosed, with the changes noted thereon.

Expedited issuance of the corrected filing receipt is respectfully requested.

Respectfully submitted,

Hiroaki INOUE et al.

By 

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December 26, 2001

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/880,005	06/14/2001	2811	1276	2001_0756A	7	23	6

CONFIRMATION NO. 4689

UPDATED FILING RECEIPT



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000513
WENDEROOTH, LIND & PONACK, L.L.P.
2033 K STREET N. W.
SUITE 800
WASHINGTON, DC 20006-1021

Date Mailed: 12/06/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Domestic Priority data as claimed by applicant

Foreign Applications

JAPAN 2001-167355 06/01/2001

If Required, Foreign Filing License Granted 08/22/2001

Projected Publication Date: 12/05/2002

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Early Publication Request: No

Title

Semiconductor
Electroless plating liquid and semiconductor device

Preliminary Class

257

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